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# Specification for Approval

Customer:	
Model Name:	

Sı	upplier Approv	Customer approval	
R&D Designed	R&D Approved	QC Approved	
Peter	Peng Jun		



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## **Revision Record**

REV NO.	REV DATE	CONTENTS	Note
Α	2023-03-25	NEW ISSUE	
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#### 1. Scope

This specification defines general provisions as well as inspection standards for TFT module supplied by AMSON electronics.

If the event of unforeseen problem or unspecified items may occur, naturally shall negotiate and agree to solution

#### 2. General Information

#### LCM

ITEM	STANDARD VALUES	UNITS
LCD type	1.28"TFT	
Dot arrangement	240(RGB)×240	dots
Color filter array	RGB vertical stripe	
Display mode	Transmission / Normally Black	
Gray Scale Inversion Direction	80/80/80	
Eyes Viewing Direction	ALL	
Driver IC	ST7789	
Module size	42.5(W) x42.5(H) x3.05(T)	mm
Active area	32.4(W) x32.4(H)	mm
Dot pitch	0.135H) x 0.135(V)	mm
Interface	4-wrie SPI	
Operating temperature	-20 ~ +60	°C
Storage temperature	-30 ~ +70	°C
Back Light	2 White LEDS	

#### **CTP**

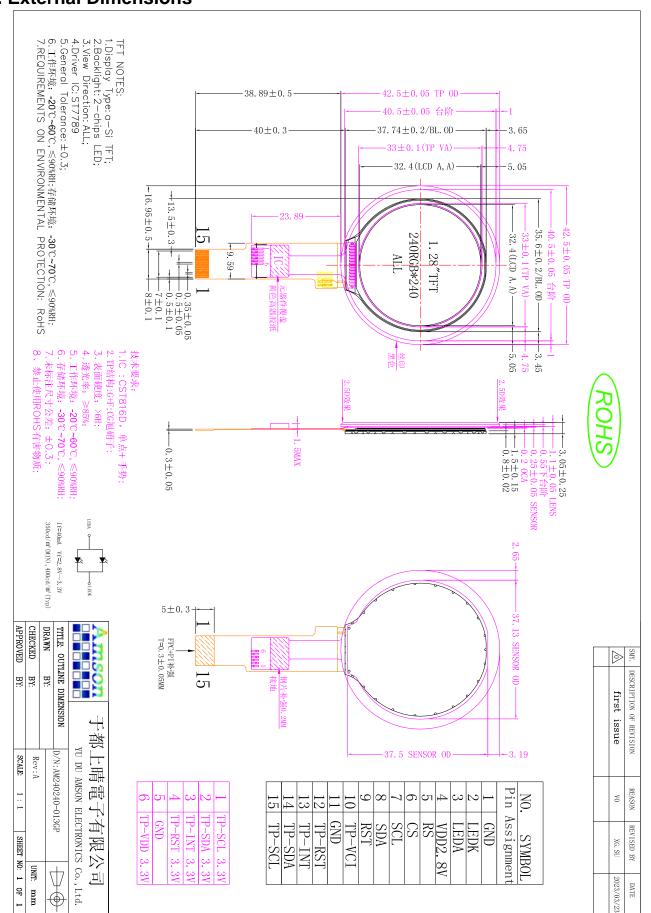
ITEM	STANDARD VALUES	UNITS
CTP type	Glass LENS +Glass LENS +FPC	
CTP Driver IC	CST816D	
Surface hardness	6H	
Transmittance	≥85%	
Operation Voltage	2.8V-3.3 V	
CTP size	42.5(W) x42.5(H) x1.35(T)	mm
CTP Viewing area	ing area 33(W)×33(H)	
CTP Interface	I <sup>2</sup> C	-



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#### 3. External Dimensions





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### 4. Interface Description

PIN NO.	PIN NAME	DESCRIPTION	
1	GND	Ground	
2	LED-K	LED backlight (Cathode).	
3	LEDA	LED backlight (Anode).	
4	VDD2.8V	Analog Supply Voltage	
5	RS	Display data/command selection pin in 4-line serial interface.	
6	CS	Chip selection pin Low enable. High disable.	
7	SCL	serial interface clock.	
8	SDA	SPI interface input pin.	
9	RESET	Reset pin. Initializes the IC, when this signal is low.  Must be reset after power is stable.	
10	TP-VCI	CTP Analog Supply Voltage 3.3V	
11	GND	Ground	
12	TP-RST	CTP Reset pin	
13	TP-INT	CTP interruption signal.	
14	TP-SDA	CTP I <sup>2</sup> C_data	
15	TP-SCL	CTP I <sup>2</sup> C_clock.	



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5. Absolute Maximum Ratings

Item	Symbol	Min.	Max.	Unit
Analog Supply Voltage	VDD	-0.3	4.6	V
Input Voltage	Vin	-0.3	VCI +0.3	V
Operating Temperature	Тор	-20	70	Ĵ
Storage Temperature	Тѕт	-30	80	°C
Storage Humidity	HD	20	90	%RH

#### 6. DC Characteristics

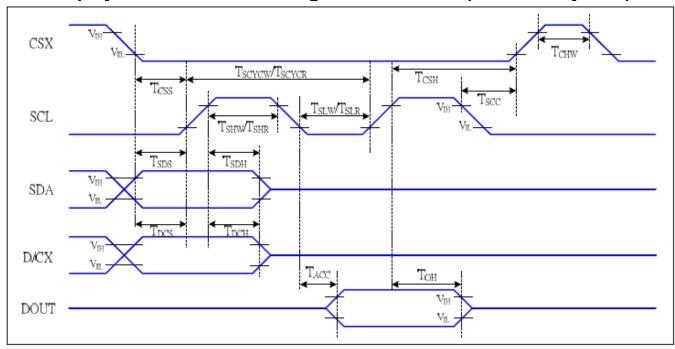
Item	Symbol	Min.	Тур.	Max.	Unit	Remark
Analog Supply Voltage	VDD	2.5	2.8	3.3	V	-
Input High Voltage	$V_{IH}$	0.7 VCI	-	VCI	V	-
Input Low Voltage	V <sub>IL</sub>	GND	-	0.3 VCI	V	-
Output High Voltage	$V_{OH}$	0.8 VCI	-	VCI	V	-
Output Low Voltage	$V_{OL}$	GND	-	0.2 VCI	V	-
I/O Leak Current	ILI	-0.1	-	0.1	uA	-

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### 7. Timing Characteristics

### 7.1 Display Serial Interface Timing Characteristics (4-line SPI system)

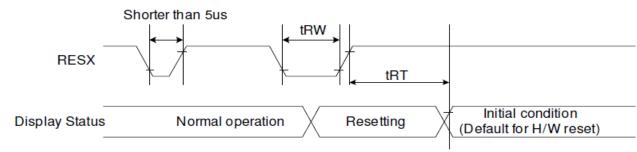


Signal	Symbol	Parameter	MIN	MAX	Unit	Description	
	T <sub>css</sub>	Chip select setup time (write)	15		ns		
	T <sub>CSH</sub>	Chip select hold time (write)	15		ns		
CSX	T <sub>CSS</sub>	Chip select setup time (read)	60		ns		
	T <sub>scc</sub>	Chip select hold time (read)	65		ns		
	T <sub>CHW</sub>	Chip select "H" pulse width	40		ns		
	T <sub>SCYCW</sub>	Serial clock cycle (Write)	66		ns	-write command & data	
	T <sub>SHW</sub>	SCL "H" pulse width (Write)	15		ns	ram	
SCL	T <sub>SLW</sub>	SCL "L" pulse width (Write)	15		ns	Taili	
SCL	T <sub>SCYCR</sub>	Serial clock cycle (Read)	150		ns	-read command & data	
	T <sub>SHR</sub>	SCL "H" pulse width (Read)	60		ns	ram	
T <sub>SLR</sub>		SCL "L" pulse width (Read)	60		ns	Tani	
D/CX	T <sub>DCS</sub>	D/CX setup time	10		ns		
DIOX	T <sub>DCH</sub>	D/CX hold time	10		ns		
SDA	T <sub>SDS</sub>	Data setup time	10		ns		
(DIN)	T <sub>SDH</sub>	Data hold time	10		ns		
DOUT	T <sub>ACC</sub>	Access time	10	50	ns	For maximum CL=30pF	
5001	Тон	Output disable time	15	50	ns	For minimum CL=8pF	

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#### 7.2 Reset Timing Characteristics

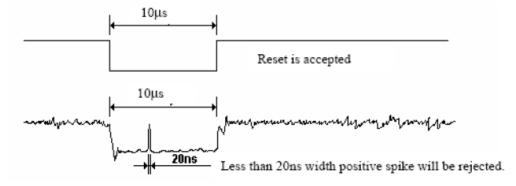


Signal	Symbol	Parameter	Min	Max	Unit
RESX	tRW	Reset pulse duration	10		uS
	tRT	Reset cancel		5 (note 1,5)	mS
	thi	neset cancer		120 (note 1,6,7)	mS

- Note 1: The reset cancel includes also required time for loading ID bytes, VCOM setting and other settings from NV memory to registers. This loading is done every time when there is HW reset cancel time (tRT) within 5 ms after a rising edge of RESX.
- Note 2: Spike due to an electrostatic discharge on RESX line does not cause irregular system reset according to the table below: -

RESX Pulse	Action
Shorter than 5us	Reset Rejected
Longer than 10us	Reset
Between 5us and 10us	Reset starts

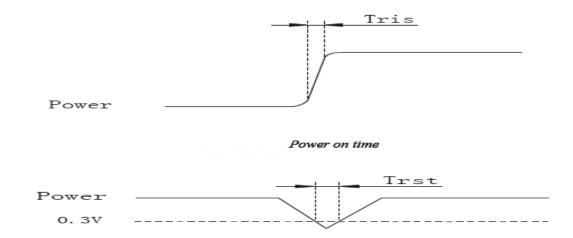
- Note 3: During the Resetting period, the display will be blanked (The display is entering blanking sequence, which maximum time is 120 ms, when Reset Starts in Sleep Out –mode. The display remains the blank state in Sleep In -mode.) And then return to Default condition for Hardware Reset.
- Note 4: Spike Rejection also applies during a valid reset pulse as shown below:



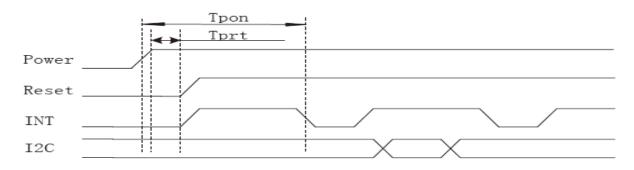
- Note 5: When Reset applied during Sleep In Mode.
- Note 6: When Reset applied during Sleep Out Mode.
- Note 7: It is necessary to wait 5msec after releasing RESX before sending commands. Also Sleep Out command cannot be sent for 120msec.

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#### 7.3 CTP POWER NO /Reset/Wake Sequence

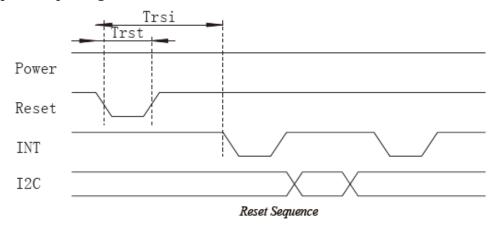


Power Cycle requirement



Power on Sequence

Reset time must be enough to guarantee reliable reset, the time of starting to report point after resetting approach to the time of starting to report point after powering on.

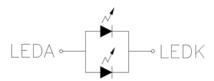




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### 8. Backlight Characteristic



Item	Symbol	MIN	TYP	MAX	UNIT	Test Condition
Supply Voltage	Vf	2.8	3.0	3.3	V	If=40mA
Supply Current	lf	-	40	-	mA	-
Luminous Intensity for LCM	-	350	400	-	Cd/m <sup>2</sup>	If=40mA
Uniformity for LCM	-	80	-	-	%	If=40mA
Life Time	-	30,000		-	Hr	If=40mA
Backlight Color	White					



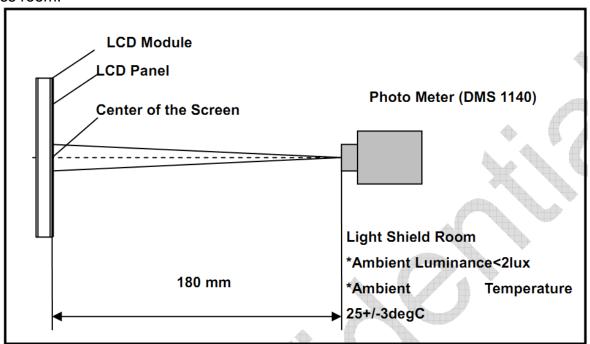
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9. Optical Characteristics

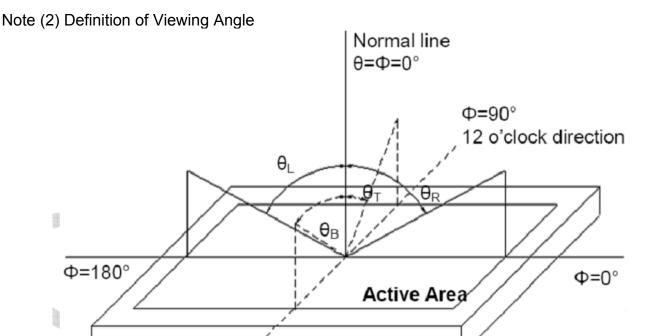
Item	Conditions		Min.	Тур.	Max.	Unit	Note	
	Horizontal	θL	-	80	-	degree		
Viewing Angle	Honzontai	θR	-	80	-		(1),(2),(6)	
(CR>10)	Vertical	θт	-	80	-			
	vertical	θв	ı	80	-			
Contrast Ratio	Center		640	800	-	-	(1),(3),(6)	
Response Time	Rising +Fall	ing	-	25	35	ms	(1),(4),(6)	
	Red x			TBD	Тур.	-		
	Red y			TBD		-		
	Green x			TBD		-		
CF Color	Green y			TBD		-	(1) (6)	
Chromaticity (CIE1931)	Blue x		Тур.	TBD		-	(1), (6)	
	Blue y	-0.05		TBD	+0.05	-		
	White x			0.313		-		
	White y			0.329				

Note (1) Measurement Setup: The LCD module should be stabilized at given temp. 25°C for 15 minutes to avoid abrupt temperature change during measuring. In order to stabilize the luminance, the measurement should be executed after lighting backlight for 15 minutes in a windless room.



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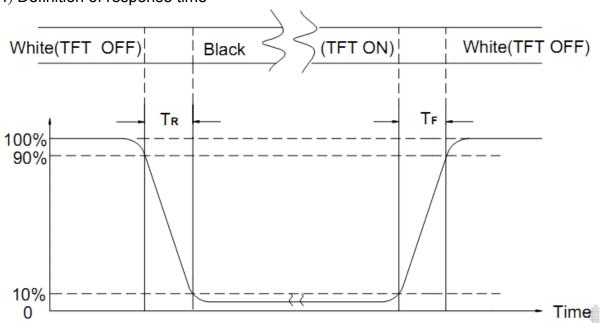
Note (3) Definition of Contrast Ratio (CR)

The contrast ratio can be calculated by the following expression Contrast Ratio (CR) = L63 / L0

Φ=270°

L63: Luminance of gray level 63, L0: Luminance of gray level 0

Note (4) Definition of response time



Note (5) Definition of Transmittance (Module is without signal input)

Transmittance = Center Luminance of LCD / Center Luminance of Back Light x 100%

Note (6) Definition of color chromaticity (CIE1931)

Color coordinates measured at the center point of LCD



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10. Reliability Test Conditions and Methods

NO.	TEST ITEMS	TEST CONDITION	INSPECTION AFTER TEST
	High Temperature Storage	70°C±2°C×96Hours	
	Low Temperature Storage	-30°C±2°C×96Hours	
	High Temperature Operating	60°C±2°C×96Hours	
	Low Temperature Operating	-20°C±2°C×96Hours	Inspection after 2~4hours storage at room temperature, the samples
	Temperature Cycle(Storage)	-20°C $\Longrightarrow$ 25°C $\Longrightarrow$ 60°C (30min) (30min) 1cycle Total 10cycle	should be free from defects: 1, Air bubble in the LCD. 2, Seal leak. 3, Non-display. 4, Missing segments.
	Damp Proof Test (Storage)	50°C±5°C×90%RH×96Hours	<ul><li>5, Glass crack.</li><li>6, Current IDD is twice</li></ul>
	Vibration Test	Frequency:10Hz~55Hz~10Hz Amplitude:1.5MM X,Y,Z direction for total 3hours (packing condition test will be tested by a carton)	higher than initial value. 7, The surface shall be free from damage. 8, The electric characteristic requirements shall be satisfied.
	Drooping Test	Drop to the ground from 1M height one time every side of carton.  (packing condition test will be tested by a carton)	orian be outloiled.
	ESD Test	Voltage:±8KV,R:330Ω,C:150PF,Air Mode,10times	

#### **REMARK:**

- 1, The Test samples should be applied to only one test item.
- 2, Sample side for each test item is 5~10pcs.
- 3,For Damp Proof Test, Pure water(Resistance  $> 10M\Omega$ )should be used.
- 4,In case of malfunction defect caused by ESD damage, if it would be recovered to normal state after resetting, it would be judge as a good part.
- 5, EL evaluation should be accepted from reliability test with humidity and temperature: Some defects such as black spot/blemish can happen by natural chemical reaction with humidity and Fluorescence EL has.
- 6, Failure Judgment Criterion: Basic Specification Electrical Characteristic, Mechanical Characteristic, Optical Characteristic.



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#### 11. Inspection Standard

#### 11.1. QUALITY:

THE QUALITY OF GOODS SUPPLIED TO PURCHASER SHALL COME UP TO THE FOLLOWING STANDARD.

#### 11.1.1. INSPECTIONTOOLS AND INSTRUMENTS

Vernier calipers, film scales, multimeter, magnifying eyepiece, ND5%, luminance meter and so on.

#### 11.1.2. THE METHOD OF PRESERVING GOODS

AFTER DELIVERY OF GOODS FROM UNI DISPLAY TO PURCHASER.
PURCHASER SHALL CONTROL THE LCM AT -10 TO 40, AND IT MIGHT BE
DESIRABLE TO KEEP AT THE NORMAL ROOM TEMPERATURE AND HUMIDITY
UNTIL INCOMING INSPECTION OR THROWING INTO PROCESS LINE.

#### 11.1.3. INCOMING INSPECTION

(A) THE METHOD OF INSPECTION

IF PURCHASER MAKE AN INCOMING INSPECTION, A SAMPLING PLAN SHALL BE APPLIED ON THE CONDITION THAT QUALITY OF ONE DELIVERY SHALL BE REGARDED AS ONE LOT.

(B) THE STANDARD OF QUALITY

ISO-2859-1 (SAME AS MIL-STD-105E ) ,LEVEL: I I

CLASS	AQL(%)
CRITICAL	0.4 %
MAJOR	0.65 %
MINOR	1.5 %

EVERY ITEM SHALL BE INSPECTED ACCORDING TO THE CLASS.

(C) MEASURE

IF AS THE RESULT OF ABOVE RECEIVING INSPECTION, A LOT OUT IS DISCOVERED. PURCHASER SHALL BE INFORM SELLER OF IT WITHIN SEVEN DAYS. BUT FIRST SHIPMENT WITHIN FOURTEEN DAYS.

#### 11.1.4. WARRANTY POLICY

UNI DISPLAY WILL PROVIDE ONE-YEAR WARRANTY FOR THE PRODUCTS ONLY IF UNDER SPECIFICATION OPERATING CONDITIONS. UNI DISPLAY WILL REPLACE NEW PRODUCTS FOR THESE DEFECT PRODUCTS WHICH UNDER WARRANTY PERIOD AND BELONG TO THE RESPONSIBILITY OF UNI DISPLAY.

#### 11.2. CHECKING CONDITION

- **11.2.1.**CHECKING DIRECTION SHALL BE IN THE 45 DEGREE AREA TO FACE THE SAMPLE.
- **11.2.2.**CHECKER SHALL SEE OVER 300±25 mm. WITH BARE EYES FAR FROM SAMPLE **11.2.3.**Ambient Illumination:

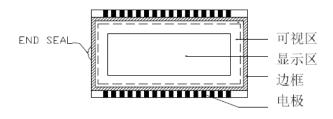
0 ~30 Lux for functional inspection

500 ~ 1200 Lux for external appearance inspection.

11.2.4. TEST AREA:

 $\longrightarrow$ 

**11.2.5.** Inspection should be carried out with rope electrostatic ring and static finger cover (both hands except small fingers must be worn)





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- **11.2.6.** The inspector may make a visual inspection or a comparative examination with a film ruler and a magnifying eyepiece. Individual defects shall be determined according to the limited samples.
- **11.2.7.** Functional testing uses electrical testing fixtures or test fixtures required by customers.
- **11.2.8.** the ion fan should be used when testing.

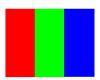
#### 11.2.9. the principle of judgment

11.3.1 If the defect outside the visual area does not affect the assembly and display, it will be judged as a good product.

#### 11.3.2 Poor definition

Pixel:

A combination of three sub-pixels (Red + Green + Blue).



#### Dot:

Any of the sub-pixels (Red or Green or Blue).







#### **Bright and dark dots:**

A point pixel (sub-pixel: R, G, B pixels) is lit or turned off during the display function test. **Highlights**:

Usually considered to be shown on a black screen.

#### Dark spots:

They are generally considered to be shown on R, G, B solid colors or white images.

#### Neighborhood:

Two or three adjacent point pixels (dot: sub-pixel) connected together (R, G or G, B or B, R or RGB).



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#### 11.3. INSPECTION PLAN:

11.0. 11401 E0	TION PLAN :		
CLASS	ITEM	JUDGEMENT	CLASS
PACKING &	1. OUTSIDE AND INSIDE PACKAGE	"MODEL NO." , "LOT NO." AND "QUANTITY" SHOULD INDICATE ON THE PACKAGE.	Minor
INDICATE	2. MODEL MIXED AND QUANTITY	OTHER MODEL MIXEDREJECTED QUANTITY SHORT OR OVERREJECTED	Critical
	3. PRODUCT INDICATION	"MODEL NO." SHOULD INDICATE ON THE PRODUCT	Major
ASSEMBLY	4. DIMENSION, LCD GLASS SCRATCH AND SCRIBE DEFECT.	ACCORDING TO SPECIFICATION OR DRAWING.	Major
	5. VIEWING AREA	POLARIZER EDGE OR LCD'S SEALING LINE IS VISABLE IN THE VIEWING AREAREJECTED	Minor
	6. BLEMISH - BLACK SPOT - WHITE SPOT IN THE LCD AND LCD GLASS CRACKS	ACCORDING TO STANDARD OF VISUAL INSPECTION(INSIDE VIEWING AREA)	Minor
APPEARANCE	7. BLEMISH - BLACK SPOT WHITE SPOT AND SCRATCH ON THE POLARIZER	ACCORDING TO STANDARD OF VISUAL INSPECTION(INSIDE VIEWING AREA)	Minor
	8. BUBBLE IN POLARIZER	ACCORDING TO STANDARD OF VISUAL INSPECTION(INSIDE VIEWING AREA)	Minor
	9. LCD'S RAINBOW COLOR	STRONG DEVIATION COLOR ( OR NEWTON RING) OF LCDREJECTED.  OR ACCORDING TO LIMITED SAMPLE ( IF NEEDED, AND INSIDE VIEWING AREA )	Minor
	10. ELECTRICAL AND OPTICAL CHARACTERISTICS ( CONTRAST, VOP, CHROMATICITY ETC )	ACCORDING TO SPECIFICATION OR DRAWING . ( INSIDE VIEWING AREA )	Critical
ELECTRICAL	11.MISSING LINE	MISSING DOT: LINE : CHARACTERREJECTED	Critical
	12.SHORT CIRCUIT WRONG PATTERN DISPLAY	NO DISPLAY - WRONG PATTERN DISPLAY - CURRENT CONSUMPTION OUT OF SPECIFICATION REJECTED	Critical
	13. DOT DEFECT (FOR COLOR AND TFT)	ACCORDING TO STANDARD OF VISUAL INSPECTION	Minor



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NO.	CLASS	ITEM	JUDGEMENT				
			(A) ROUND TYPE:		unit: mm_		
			DIA	METER (mm.)	ACCEPTABLE Q'TY		
			Ø≤ <b>0</b> .1		Ø≤ <b>0</b> .1		Disregard
			0.1	< ∅ ≤ 0.25	3 (Distance ≥ 5mm)		
		DI AOK AND		0.25 < ∅	0		
		BLACK AND WHITE SPOT	NOT	E: ∅=(LENGTH*W	/IDTH)/2		
		FOREIGN MATERIEL DUST	(S) ROUN	ND TYPE:	unit: mm		
11.4.1	MINOR	IN THE CELL	LENGTH	WIDTH	ACCEPTABLE QTY		
		BLEMISH		W≤ 0.03	Disregard		
		SCRATCH	L ≤5.0	0.03 < W ≤ 0.07	7 3 (Distanced ≥ 5mm		
				0.07 < W	FOLLOW ROUND TYPE		
			NOTE: Ø	=(LENGTH*WIDTH	H)/2		
					unit: mm.		
		BUBBLE IN		DIAMETER	ACCEPTABLE Q'TY		
		POLARIZER		Ø<0.2	Disregard		
11.4.2	11.4.2 MINOR DENT ON POLARIZER		0	.2<∅≤ 0.3	2(Distance≥ 15mm)		
				0.3<Ø	0		
				Items	ACC. Q'TY		
				Bright dot	N ≤4(Distance ≥ 5mm)		
				Dark dot	N ≤4(Distance ≥ 5mm)		
				Pixel  Pixel  Dot Dot Dot Dot Hefinition of dot: Th	e size of a defective dot over 1 of		
11.4.3	MINOR	Dot Defect	<ul> <li>whole dot is regarded as one defective dot. Definition:&lt;1/2 dot and visible by 5% ND filter</li> <li>Bright dot: Dots appear bright and unchanged in size m which LCD panel is displaying under black pattern.</li> <li>Dark dot: Dots appear dark and unchanged in size ir which LCD panel is displaying under pure Red, Green, Blue pattern.</li> </ul>				
11.4.3.1	MINOR	Mura	Not visible through 5% ND filter in 50% gray or judge by limit sample if necessary				



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NO.	CLASS	ITEM	JUDGEMEN	Т
11.4.4	MINOR	LCD GLASS CHIPPING	S	Y > S Reject
11.4.5	MINOR	LCD GLASS CHIPPING	SIN	X or Y > S Reject
11.4.6	MAJOR	LCD GLASS GLASS CRACK	Y	Y > (1/2) T Reject
11.4.7	MAJOR	LCD GLASS SCRIBE DEFECT	A + B	<ol> <li>a&gt; L/3 , A&gt;1.5mm. Reject</li> <li>B: ACCORDING TO DIMENSION</li> </ol>
11.4.8	MINOR	LCD GLASS CHIPPING ( ON THE TERMINAL AREA )	T	$\Phi = (x+y)/2 > 2.5 \text{ mm}$ Reject
11.4.9	MINOR	LCD GLASS CHIPPING ( ON THE TERMINAL SURFACE )	TZX	Y > (1/3) T Reject
11.4.10	MINOR	LCD GLASS CHIPPING	T Z	Y > T Reject



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#### 11.5 INSPECTION STANDARD OF TOUCH PANEL

NO.	CLASS	ITEMS		JUDGEMENT			
11.5.1	MAJOR	Touch Panel Crack			Reject		
11.5.2	11.5.2 MINOR	IINOR Touch Panel Chipping	Corner	$X \le 2mm, Y \le 2mm, Z < 1/2T$	Accept		
11.5.2			Edge	X ≤ 3mm, Y ≤ 3mm, Z < 1/2T	Accept		
			0	W≦0.05, L≦20mm	Accept		
11.5.3	.3 MINOR Dust and		Scratch Foreign materiel inear Type)	0.05mm <w≦0.07mm; l≦10.0mm<br="">Distance between seratch&gt;5.0mm</w≦0.07mm;>	Accept 3 ea Max.		
				W>0.07mm	Reject		
				Φ ≤ 0.25mm	Accept		
11.5.4		Scratch Dust and Foreign materiel (Round Type: Φ=(Length+Width)/2)	$0.25 mm < \Phi \le 0.35 mm$ Distance between spots $> 5.0 mm$	Accept 5 ea Max.			
				Φ>0.35mm	Reject		
				Φ ≦ 0.35mm	Accept		
11.5.5	MINOR	DR Touch Panel Dent / Fish Eyes		0.35mm < Φ ≦ 1.0mm Distance > 5.0mm	Accept 3 ea Max.		
				Φ > 1.0mm	Reject		
				Φ ≦ 0.2mm	Accept		
11.5.6	i.6 MINOR Touch Panel Air Bubble			0.2mm < ⊕ ≦0.5mm Distance between bubbles > 5.0mm	Accept 3 ea Max.		
				Φ > 0.5mm	Reject		
11.5.7	4.5.7. MINOR Touch Pane		ouch Panel	W≦0.05mm, L≦5mm Distance between scratch>5.0mm	Accept 3 ea Max.		
11.5./	WIINOR	IINOR Printing area Scratch		W>0.05mm or L>5mm ( W>0.05 Follow 11.5.4 Round type )	Reject		
11.5.8	MINOR	Touch Panel White Haze Mark / Dust		Can not be removed	Reject		



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#### 12. Handling Precautions

#### 12.1 Mounting method

The LCD panel of AMSON TFT module consists of two thin glass plates with polarizes which easily be damaged. And since the module in so constructed as to be fixed by utilizing fitting holes in the printed circuit board.

Extreme care should be needed when handling the LCD modules.

#### 12.2 Caution of LCD handling and cleaning

When cleaning the display surface, Use soft cloth with solvent

[Recommended below] and wipe lightly

- Isopropyl alcohol
- Ethyl alcohol

Do not wipe the display surface with dry or hard materials that will damage the polarizer surface.

Do not use the following solvent:

- Water
- Aromatics

Do not wipe ITO pad area with the dry or hard materials that will damage the ITO patterns Do not use the following solvent on the pad or prevent it from being contaminated:

- Soldering flux
- Chlorine (CI), Sulfur (S)

If goods were sent without being silicon coated on the pad, ITO patterns could be damaged due to the corrosion as time goes on.

If ITO corrosion happen by miss-handling or using some materials such as Chlorine (CI), Sulfur (S) from customer, Responsibility is on customer.

#### 12.3 Caution against static charge

The LCD module use C-MOS LSI drivers, so we recommended that you:

Connect any unused input terminal to POWER or GND, do not input any signals before power is turned on, and ground your body, work/assembly areas, and assembly equipment to protect against static electricity.

#### 12.4 packing

- Module employs LCD elements and must be treated as such.
- Avoid intense shock and falls from a height.
- To prevent modules from degradation, do not operate or store them exposed direct to sunshine or high temperature/humidity

#### 12.5 Caution for operation

- It is an indispensable condition to drive LCD's within the specified voltage limit since the higher voltage then the limit cause the shorter LCD life.
- An electrochemical reaction due to direct current causes LCD's undesirable deterioration, so that the use of direct current drive should be avoided.
- Response time will be extremely delayed at lower temperature then the operating temperature range and on the other hand at higher temperature LCD's how dark color in them. However those phenomena do not mean malfunction or out of order with LCD's, which will come back in the specified operation temperature.
- If the display area is pushed hard during operation, some font will be abnormally displayed but it resumes normal condition after turning off once.
- Slight dew depositing on terminals is a cause for electro-chemical reaction resulting in terminal open circuit.
  - Usage under the maximum operating temperature, 50%Rh or less is required.



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#### 12.6 storing

In the case of storing for a long period of time for instance, for years for the purpose or replacement use, the following ways are recommended.

- Storage in a polyethylene bag with the opening sealed so as not to enter fresh air outside in it. And with no desiccant.
- Placing in a dark place where neither exposure to direct sunlight nor light's keeping the storage temperature range.
- Storing with no touch on polarizer surface by the anything else.
   [It is recommended to store them as they have been contained in the inner container at the time of delivery from us

#### 12.7 Safety

- It is recommendable to crash damaged or unnecessary LCD's into pieces and wash off liquid crystal by either of solvents such as acetone and ethanol, which should be burned up later.
- When any liquid leaked out of a damaged glass cell comes in contact with your hands, please wash it off well with soap and water

#### 13. Precaution for Use

#### 13.1

A limit sample should be provided by the both parties on an occasion when the both parties agreed its necessity. Judgment by a limit sample shall take effect after the limit sample has been established and confirmed by the both parties.

#### 13.2

On the following occasions, the handing of problem should be decided through discussion and agreement between responsible of the both parties.

- When a question is arisen in this specification
- When a new problem is arisen which is not specified in this specifications
- When an inspection specifications change or operating condition change in customer is reported to AMSON TFT, and some problem is arisen in this specification due to the change
- When a new problem is arisen at the customer's operating set for sample evaluation in the customer site.

## 14. Packing Method TBD.